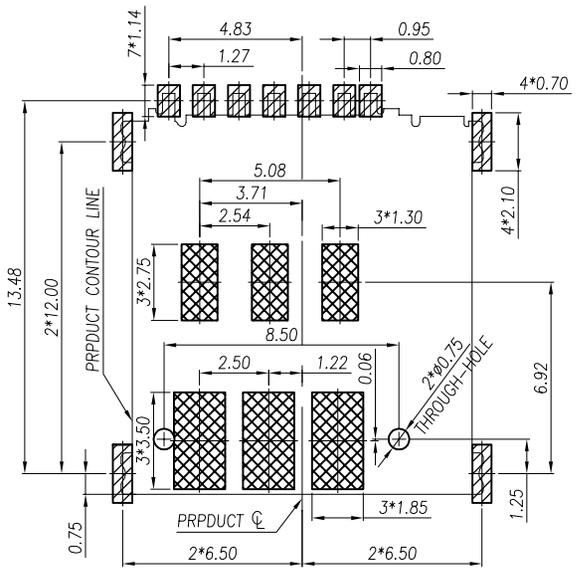
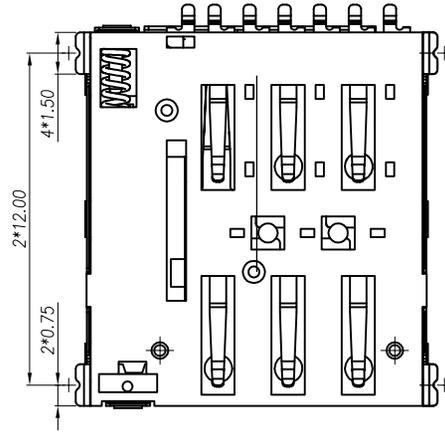
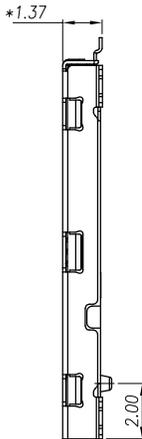
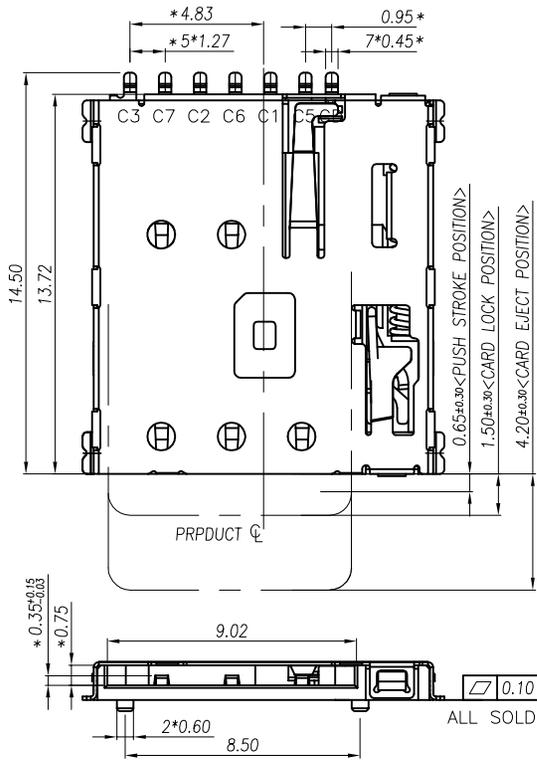


ROHS

REV.	Q'TY	ECN. NO.	APR.	DATE
A		FIRST RELEASE	Yann	2021.03.11

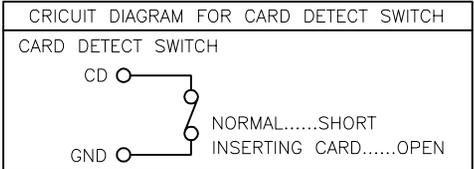


RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)
RECOMMENDED MATAL MASK T=0.12mm

- SMT SOLDER AREA
- NO PATTERN AND VIA HOLE IN HTIS AREA

NOTES:
1.MATERIAL:
HOUSING: High Temperature Thermoplastic
Terminal:Copper Alloy
Shell: Stainless Steel
2.PLATING:
Terminal:50u" Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA AND SOLDER AREA
Shell:30u" Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA AND SOLDER AREA
3.TECHNICAL SPECIALITY:
RATED VOLTAGE: 30V AC MAX.
CURRENT RATING: 0.5A MAX.
INSULATION RESISTANCE:1000MΩ MIN
CONTACT REISTANCE:50mΩ MAX
WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES
OPERATING TEMPERATURE:
-25°C~+85°C Humidity 80% R.H MAX
4.DIMENSIONS WITH MARK * "MUST BE MEASURE
BY QC AND IPQC

PIIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O



PART INSTRUCTIONS:

PART NUMBER	DESCRIPTION
SM007-2B137A071	WITH POST
SM007-2B137A07N	NO POST

DIMENSION IN mm

TOLERANCE UNLESS OTHERWISE SPECIFIED

.X±0.35	X.*± 5°
.XX±0.25	.X.*± 3°
.XXX±0.15	.XX.*± 1°

**Dongguan JianXing
Electronics Co.,Ltd.**

APR. _____

CHK. _____

DRA. Yann

TITLE: 1.37H NANO SIM CARD CONNECTOR

DWG NO. SEE INSTRUCTIONS

PROJ. CUSTOMER DRAWING

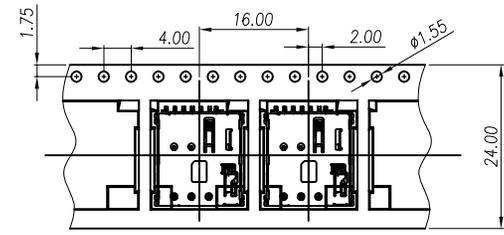
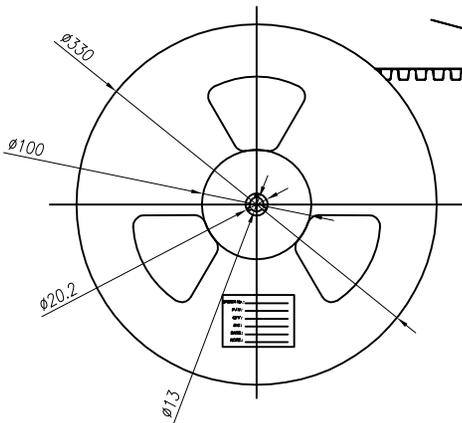
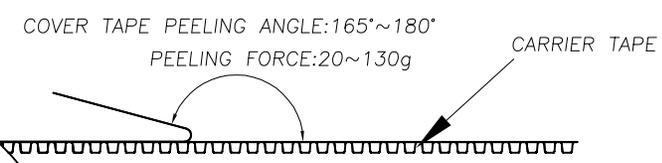
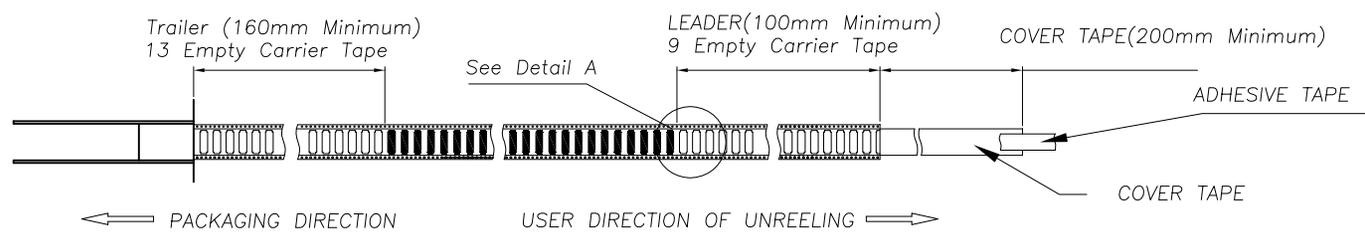
SIZE A4 SCALE 4:1 SHEET 1/2 REV. A

ROHS

REV.	Q'TY	ECN. NO.	APR.	DATE
A		FIRST RELEASE	Jason	2021.03.11

A
B
C
D
E
F

A
B
C
D
E
F



2	SM007-2B137A071	1500	10		15000	350X350X340
1	SM007-2B137A07N	1500	10		15000	350X350X340
ITEM	PRODUCT NO	QTY/REEL	REEL/CARTON	Kg/CARTON	QTY/CARTON	CARTON SIZE

DIMENSION IN mm			Dongguan JianXing Electronics Co.,Ltd.	
TOLERANCE UNLESS OTHERWISE SPECIFIED				
.X±0.35	X'± 5'	APR.	TITLE: 1.37H NANO SIM CARD CONNECTOR	
.XX±0.25	.X'± 3'	CHK.	DWG NO. SEE INSTRUCTIONS	
.XXX±0.15	.XX'± 1'	DRA. Yann	PROJ.	CUSTOMER DRAWING
			SIZE A4	SCALE 1:4
			SHEET 2/2	REV. A